

Single N-Channel MOSFET

DESCRIPTION

SMC6216 is the N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior, fast switching performance, and withstand high energy pulse in the avalanche and commutation mode.

PART NUMBER INFORMATION

SMC 6216 J - TR G
 a b c d e

- a : Company name.
- b : Product Serial number.
- c : Package code J:SOT-223
- d : Handling code TR:Tape&Reel
- e : Green produce code G:RoHS Compliant

FEATURES

$V_{DS} = 60V$, $I_D = 5.3A$

$R_{DS(ON)} = 58m\Omega (Typ.) @ V_{GS} = 10V$
 $R_{DS(ON)} = 66m\Omega (Typ.) @ V_{GS} = 4.5V$

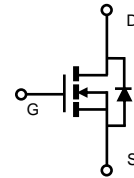
- ◆ 100% EAS Guaranteed
- ◆ Improved dv/dt capability
- ◆ Fast switching

APPLICATIONS

- ◆ LED applications
- ◆ Transformer Driving Switch
- ◆ Motor drive
- ◆ Power Management



SOT-223



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ C$ Unless otherwise noted)

| Symbol | Parameter | Rating | Units |
|-----------|-------------------------------------------------------|--------------------|------------|
| V_{DS} | Drain-Source Voltage | 60 | V |
| V_{GS} | Gate-Source Voltage | ± 20 | V |
| I_D | Continuous Drain Current | $T_A = 25^\circ C$ | 5.3 A |
| | | $T_A = 70^\circ C$ | 4.3 A |
| I_{DM} | Pulsed Drain Current ^A | 21 | A |
| I_{AS} | Avalanche Current ^A | 8 | A |
| EAS | Single Pulse Avalanche energy $L=0.3mH$ ^{AD} | 9.5 | mJ |
| P_D | Power Dissipation ^B | $T_A = 25^\circ C$ | 3.1 W |
| | | $T_A = 70^\circ C$ | 2 W |
| T_J | Operation Junction Temperature | -55/150 | $^\circ C$ |
| T_{STG} | Storage Temperature Range | -55/150 | $^\circ C$ |

THERMAL RESISTANCE

| Symbol | Parameter | Typ | Max | Units |
|-----------------|------------------------------------------------------|--------------|-----|--------------|
| $R_{\theta JA}$ | Thermal Resistance Junction to Ambient ^B | $t \leq 10s$ | 40 | $^\circ C/W$ |
| | Thermal Resistance Junction to Ambient ^{Bc} | Steady-State | 75 | |
| $R_{\theta JC}$ | Thermal Resistance Junction to Case | | 30 | |

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ Unless otherwise noted)

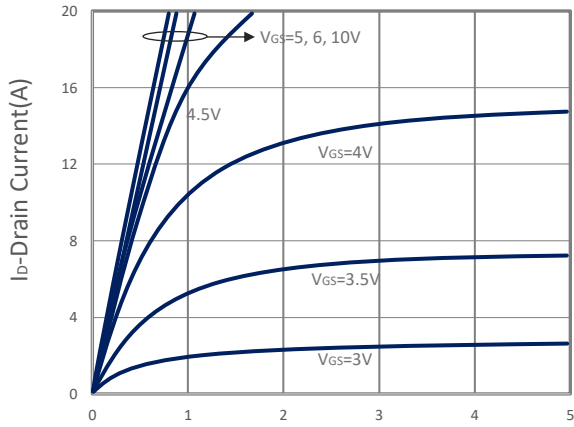
| Symbol | Parameter | Condition | Min | Typ | Max | Unit |
|-----------------------------------------|-----------------------------------------|---------------------------------------------------------------------------------------------------|-----|----------|-----------|------------|
| Static Parameters | | | | | | |
| BV _{DSS} | Drain-Source Breakdown Voltage | V _{GS} =0V, I _D =250 μ A | 60 | | | V |
| V _{GS(th)} | Gate Threshold Voltage | V _{DS} =V _{GS} , I _D =250 μ A | 1.2 | 1.8 | 2.5 | V |
| I _{GSS} | Gate Leakage Current | V _{DS} =0V, V _{GS} = \pm 20V | | | \pm 100 | nA |
| I _{DSS} | Zero Gate Voltage Drain Current | V _{DS} =60V, V _{GS} =0V, T _J =25 $^\circ$ C | | | 1 | μ A |
| | | V _{DS} =48V, V _{GS} =0V, T _J =75 $^\circ$ C | | | 10 | |
| R _{DS(ON)} | Drain-source On-Resistance ^E | V _{GS} =10V, I _D =5.3A V _{GS} =4.5V, I _D =3.5A | | 58 66 | 64 76 | m Ω |
| G _{fs} | Forward Transconductance | V _{DS} =10V, I _D =3.5A | | 6.8 | | S |
| Diode Characteristics | | | | | | |
| V _{SD} | Diode Forward Voltage ^E | I _S =1A, V _{GS} =0V | | | 1 | V |
| I _S | Continuous Source Current | | | | 3.5 | A |
| t _{rr} | Reverse Recovery Time | I _S =1A, di/dt=100A/ μ s | | 22.8 | | ns |
| Q _{rr} | Reverse Recovery Charge | T _J =25 $^\circ$ C | | 13.6 | | nC |
| Dynamic and Switching Parameters | | | | | | |
| Q _g | Total Gate Charge | V _{DS} =30V, V _{GS} =10V, I _D =3.5A | | 9.2 | 13.8 | nC |
| Q _g | Total Gate Charge (4.5V) | | | 4.5 | 6.8 | |
| Q _{gs} | Gate-Source Charge | | | 2.3 | 3.5 | |
| Q _{gd} | Gate-Drain Charge | | | 1.8 | 2.7 | |
| C _{iss} | Input Capacitance | V _{DS} =30V, V _{GS} =0V, f=1MHz | | 495 | | pF |
| C _{oss} | Output Capacitance | | | 43 | | |
| C _{rss} | Reverse Transfer Capacitance | | | 15 | | |
| R _g | Gate Resistance | V _{GS} =0V, V _{DS} =0V, F=1MHz | | 1.95 | | Ω |
| t _{d(on)} | Turn-On Time | V _{DD} =30V, V _{GEN} =10V, R _G =3.3 Ω , I _D =1A | | 3.1 | 9 | nS |
| t _r | | | | 9.2 | 18 | |
| t _{d(off)} | Turn-Off Time | | | 17.5 | 35 | |
| t _f | | | | 5.5 | 10 | |

Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged.

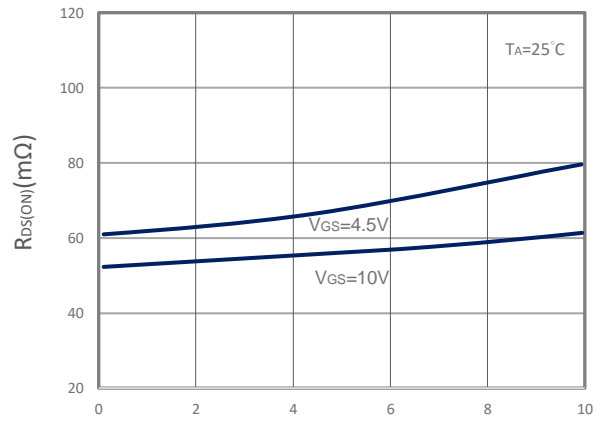
- Pulsed width limited by maximum junction temperature, T_{J(MAX)}=150 $^\circ$ C.
- The value of R θ JA is measured with the device mounted on 1in2 FR-4 board in a still air environment with maximum junction temperature T_{J(MAX)}=150 $^\circ$ C (initial temperature T_A=25 $^\circ$ C).
- T_{J(MAX)}=150 $^\circ$ C, using junction-to-case thermal resistance (R θ JC) is more useful in additional heat sinking is used.
- The EAS data shows Max, tested and pulse width limited by T_{J(MAX)}=150 $^\circ$ C (initial temperature T_J=25 $^\circ$ C).

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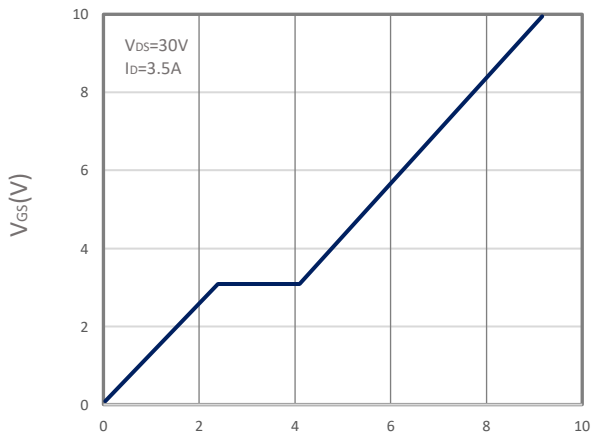
TYPICAL CHARACTERISTICS



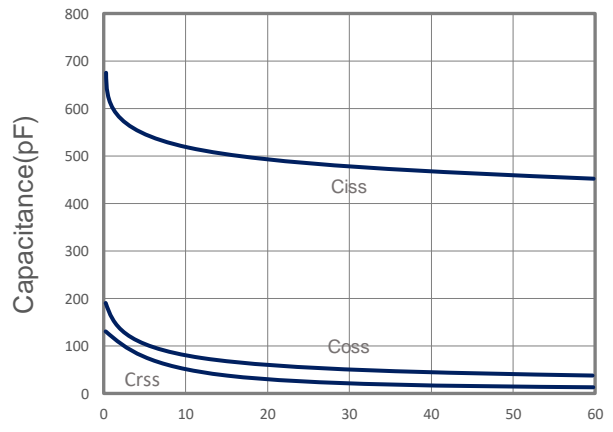
Output Characteristics



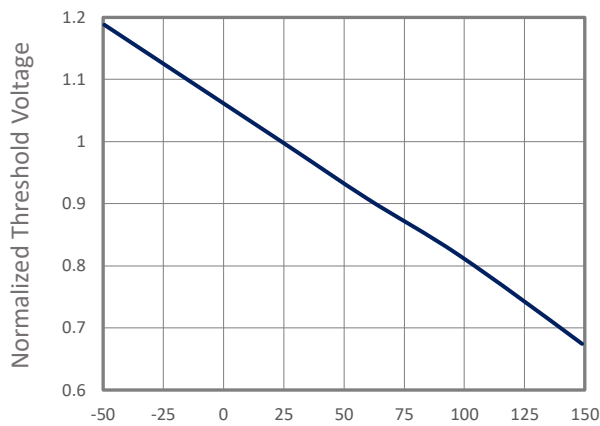
Drain-Source On Resistance



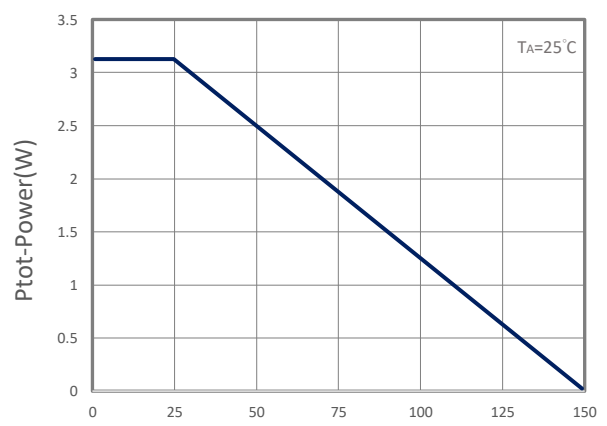
Gate Charge



Capacitance

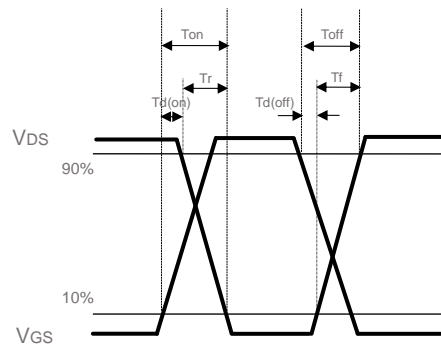
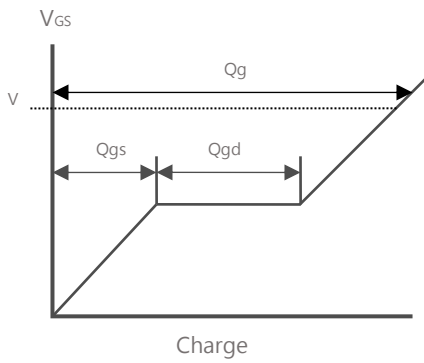
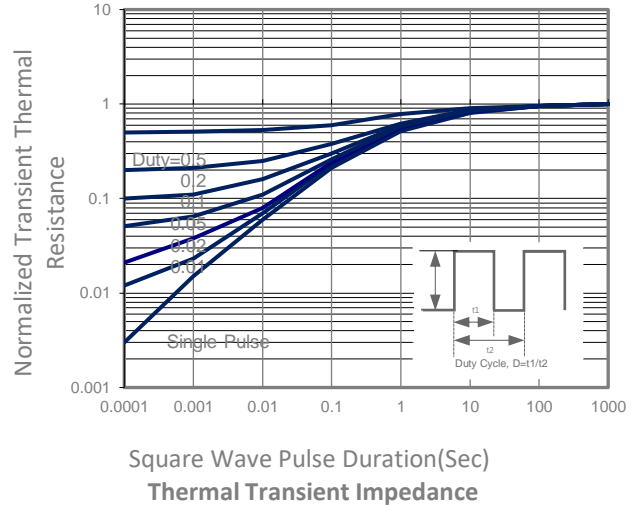
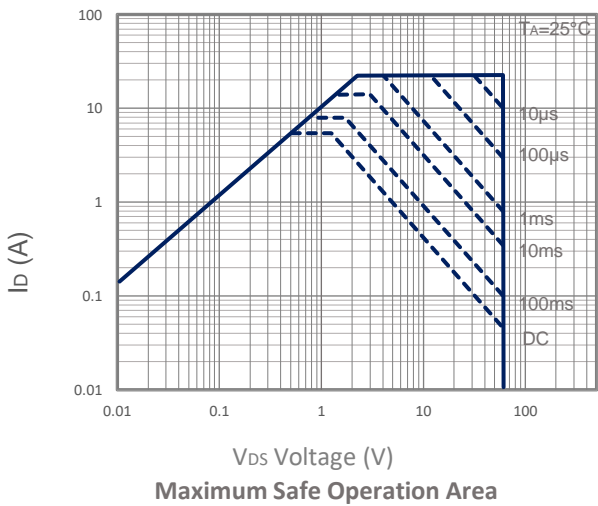
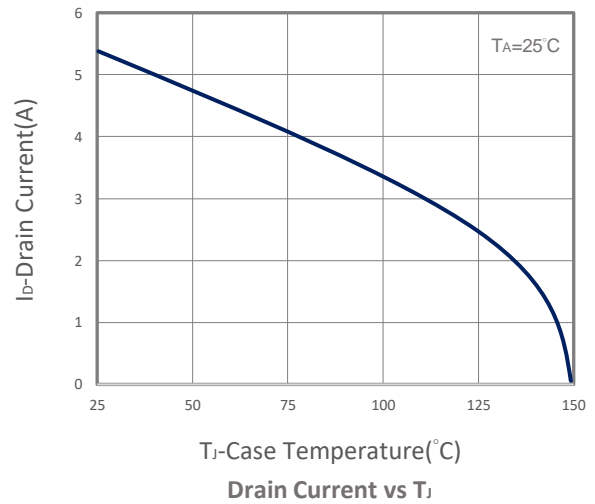
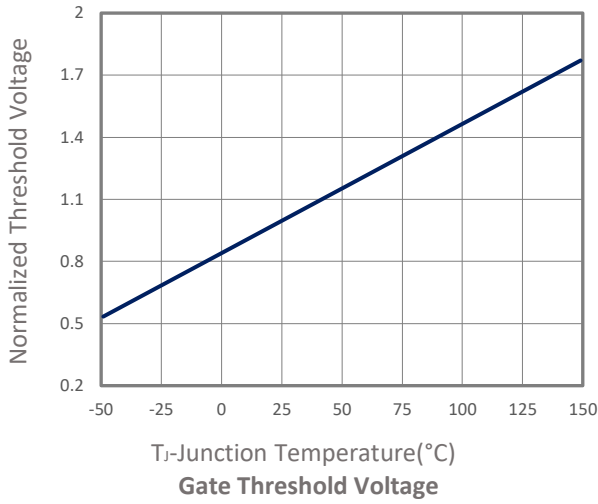


Gate Threshold Voltage

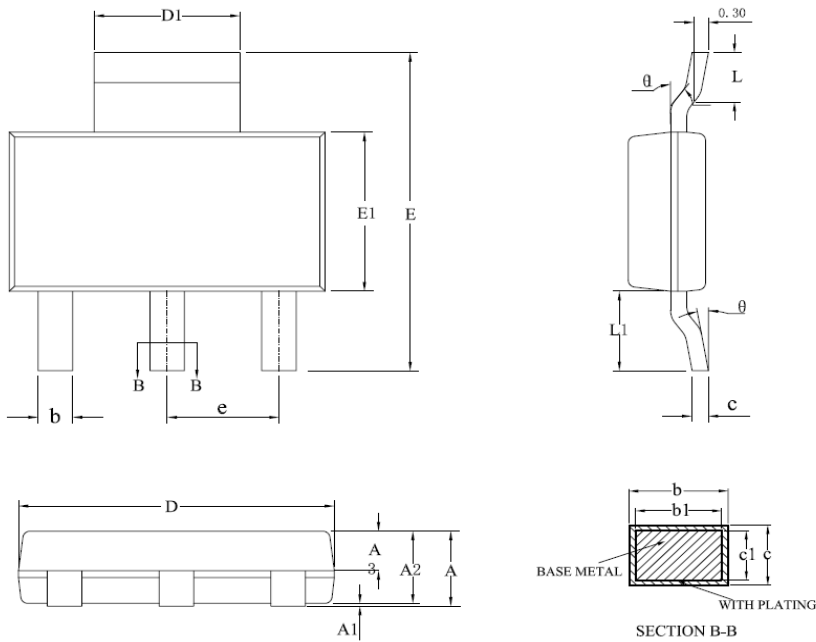


Power Dissipation

TYPICAL CHARACTERISTICS



SOT-223 PACKAGE DIMENSIONS



| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|---------------------------|-------|----------------------|-------|
| | Min. | Max. | Min. | Max. |
| A | 1.520 | 1.800 | 0.060 | 0.071 |
| A1 | 0.000 | 0.100 | 0.000 | 0.004 |
| A2 | 1.500 | 1.700 | 0.059 | 0.067 |
| A3 | 0.800 | 1.000 | 0.031 | 0.039 |
| b | 0.660 | 0.820 | 0.026 | 0.032 |
| b1 | 0.680 | 0.740 | 0.027 | 0.029 |
| c | 0.300 | 0.350 | 0.012 | 0.014 |
| c1 | 0.290 | 0.310 | 0.011 | 0.012 |
| D | 6.200 | 6.400 | 0.244 | 0.252 |
| D1 | 2.900 | 3.100 | 0.114 | 0.122 |
| E | 6.830 | 7.070 | 0.269 | 0.278 |
| E1 | 3.300 | 3.700 | 0.130 | 0.146 |
| e | 2.300 BSC. | | 0.091 BSC. | |
| L | 0.900 | 1.150 | 0.035 | 0.045 |
| L1 | 1.75 BSC. | | 0.069 BSC. | |
| θ | 0° | 10° | 0° | 10° |